

FCH25N60N N-Channel SupreMOS[®] MOSFET 600 V, 25 A, 126 mΩ

Features

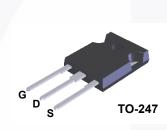
- R_{DS}(on) = 108 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 12.5 A
- Ultra Low Gate Charge (Typ. Q_q = 57 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 262 pF)
- 100% Avalanche Tested
- · RoHS Compliant

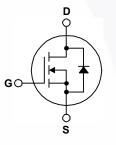
Application

- · Solar Inverter
- AC-DC Power Supply

Description

The SupreMOS[®] MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FCH25N60N	Unit	
V _{DSS}	Drain to Source Voltage			600	V	
V _{GSS}	Gate to Source Voltage			±30	V	
	Drain Current	- Continuous (T _C = 25 ^o C)		25		
ID	Drain Current	- Continuous (T _C = 100 ^o C)		16	A	
I _{DM}	Drain Current	- Pulsed (A	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			861	mJ	
I _{AR}	Avalanche Current (Note 1)			8.3	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)			2.2	mJ	
dv/dt	MOSFET dv/dt			100	1//22	
	Peak Diode Recovery dv/dt (Note 3)			20	V/ns	
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		216	W	
		- Derate Above 25°C		1.72	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

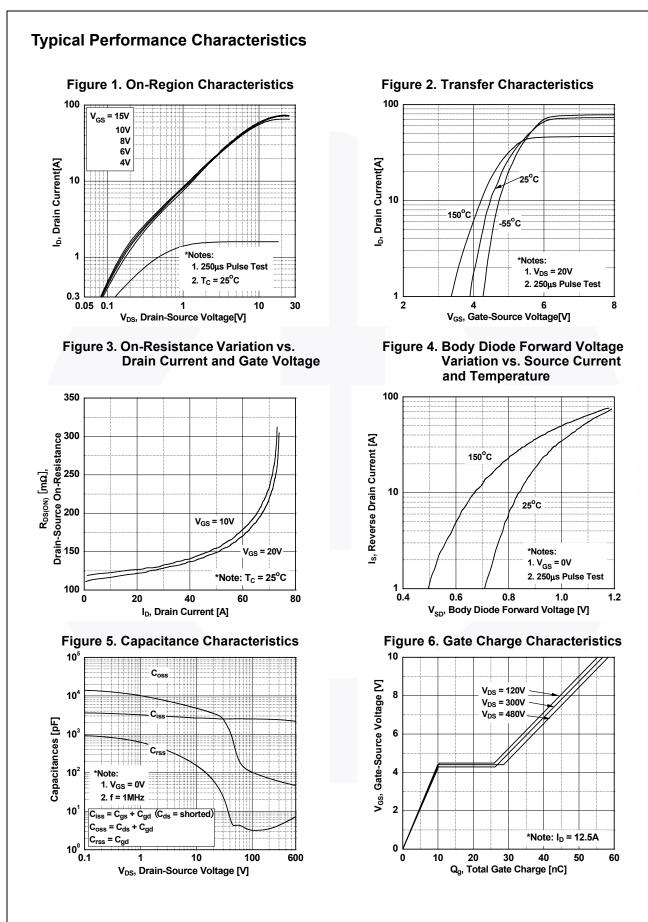
Thermal Characteristics

Symbol	Parameter	FCH25N60N	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.58	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	0/11

December 2013

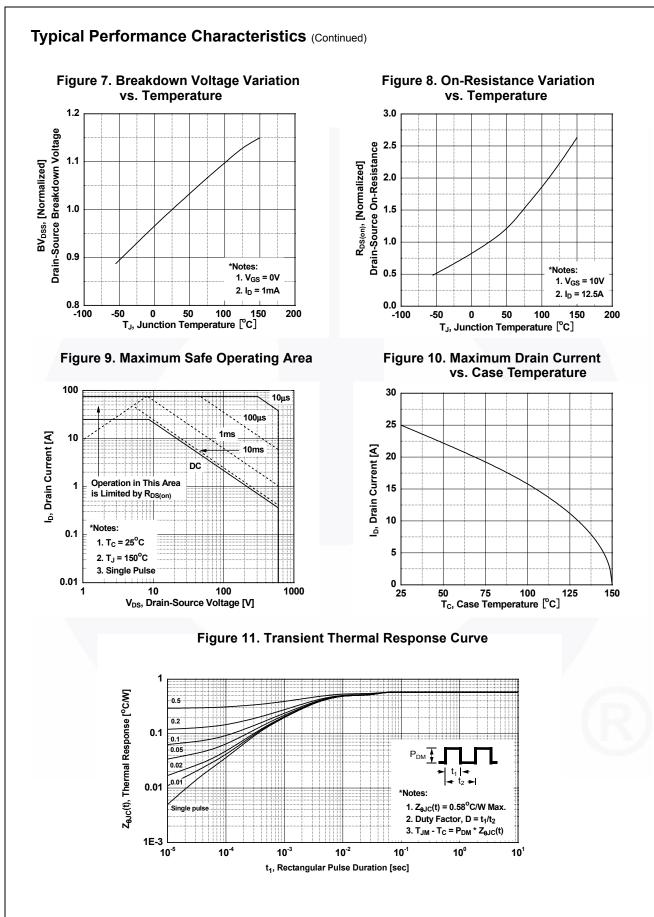
FCH25N60N
— N-Channel
I SupreMOS®
MOSFET

Part Nur	Part Number Top Mark		Package	Packing Method	Reel Siz	e	Tape Width	Qu	antity	
FCH25N	160N	FCH25N60N	TO-247	Tube	N/A		N/A	30	30 units	
Electrica	l Chara	acteristics T _C = 25°C	unless othe	rwise noted.						
Symbol		Parameter		Test Conditions	S	Min.	Тур.	Max.	Unit	
Off Charac	teristics	i i								
BV _{DSS}	Drain to	Source Breakdown Voltage	I _D =	1 mA, V _{GS} = 0 V,T _J =	• 25°C	600	-	-	V	
ΔΒV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient		I _D =	$I_D = 1$ mA, Referenced to 25°C		-	0.74	-	V/ºC	
I _{DSS}	Zero Gat	e Voltage Drain Current		V _{DS} = 480 V, V _{GS} = 0 V		-	-	10	μA	
				= 480 V, T _J = 125 ^o C		-	-	100		
I _{GSS}	Gate to E	Body Leakage Current	V _{GS}	$s = \pm 30 \text{ V}, \text{ V}_{\text{DS}} = 0 \text{ V}$		-	-	±100	nA	
On Charac	teristics									
V _{GS(th)}	Gate Th	eshold Voltage	VGS	_S = V _{DS} , I _D = 250 μA		2.0	-	4.0	V	
R _{DS(on)}	Static Dr	ain to Source On Resistance		s = 10 V, I _D = 12.5 A		-	0.108	0.126	Ω	
Dynamic C	haracto	rietice								
C _{iss}		pacitance				-	2520	3352	pF	
C _{iss} C _{oss}		apacitance	V _{DS}	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		-	103	137	pF pF	
		Transfer Capacitance	f = '			-	3.2	5	pF	
C _{rss}			V	- 280 \/ \/ - 0 \/ f			55	5	pF	
C _{oss}		Dutput Capacitance $V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Effective Output Capacitance $V_{DS} = 0 \text{ V}$ to 480 V, $V_{GS} = 0 \text{ V}$			-	262	-			
C _{oss(eff.)}						-	57	- 74	pF nC	
Q _{g(tot)}		te Charge at 10V		s = 380 V, I _D = 12.5 A,	-	-	10	74	nC	
Q _{gs}		Source Gate Charge	VGS	_s = 10 V	(Note 4)	-	-	-	-	
Q _{gd}		Drain "Miller" Charge	6 - 1	4	(1000 4)	-	18	-	nC	
ESR	Equivale	nt Series Resistance (G-S)	1 =	1 MHz		-	1	-	Ω	
Switching	Charact	eristics								
t _{d(on)}	Turn-On	Delay Time				-	21	52	ns	
t _r	Turn-On	Rise Time		V_{DD} = 380 V, I _D = 12.5 A, V _{GS} = 10 V, R _G = 4.7 Ω		-	22	54	ns	
t _{d(off)}	Turn-Off	Delay Time	V _{GS}			-	68	146	ns	
t _f	Turn-Off	Fall Time			(Note 4)	-	5	20	ns	
Drain Sour		e Characteristics	1							
	1	n Continuous Drain to Source	Diodo For	ward Current		-	1 1	25	A	
l _s		Pulsed Drain to Source Dio						75	A	
I _{SM}		Source Diode Forward Voltag		_s = 0 V, I _{SD} = 12.5 A		_		1.2	V	
V _{SD}		Recovery Time				_	370	-	ns	
t _{rr}		Recovery Charge		_s = 0 V, I _{SD} = 12.5 A, dt = 100 A/μs		-	7	-	μC	
Q _{rr} Notes:				1007840			, ,	F	μο	
. Repetitive rating 2. I _{AS} = 8.3 A, R _G =	•	mited by maximum junction temperatu	ie.							
		J TJ = 25°C. DD ≤ 380 V, starting TJ = 25°C.								
		$_{DD} \leq 300$ v, starting $T_{J} = 25$ C. rating temperature typical characterist	ics.							



©2011 Fairchild Semiconductor Corporation FCH25N60N Rev. C1

www.fairchildsemi.com

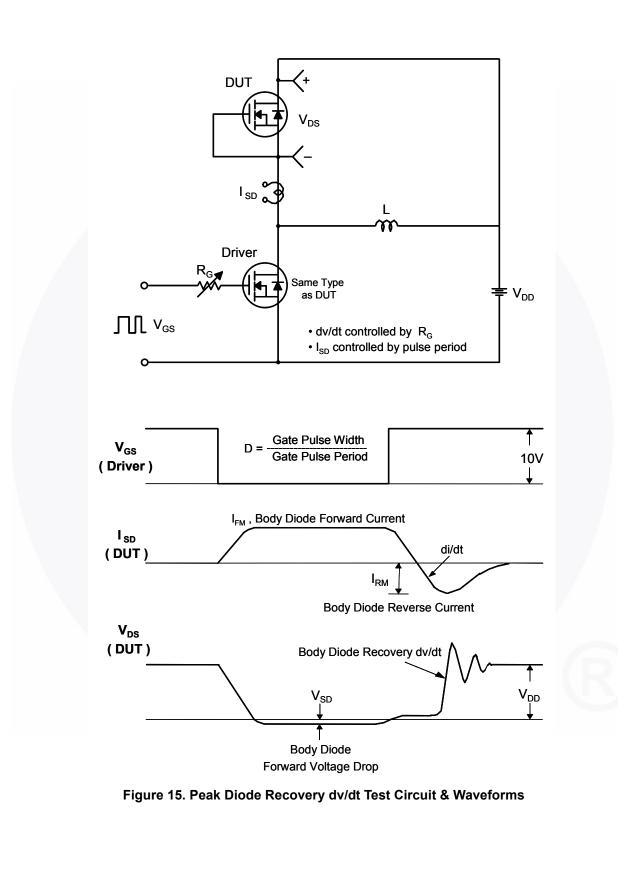


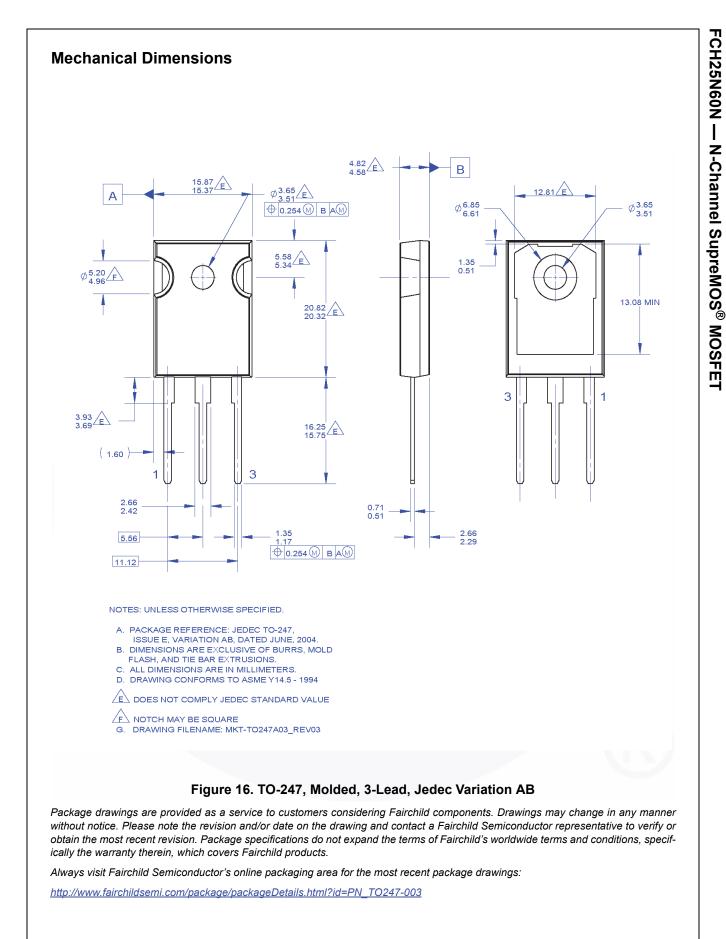
4

 V_{GS} ξ א Q_g FV_{DS} Q_{gd} Q_{gs} • DUT I_G = const. Charge Figure 12. Gate Charge Test Circuit & Waveform R VDS V_{DS} 90% ο V_{DD} GS R_{G} 10% V_{GS} DUT V_{GS} ∏ 0 Figure 13. Resistive Switching Test Circuit & Waveforms L $E_{AS} = \frac{1}{2} L I_{AS}^2$ V_{DS} $\mathsf{BV}_{\mathsf{DSS}}$ ID o I_{AS} R_{G} ≑ V_{DD} $I_{D}(t)$ $\mathsf{V}_{\mathsf{D}\mathsf{D}}$ V_{GS}] $V_{DS}(t)$ DUT Time t_p Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

FCH25N60N — N-Channel SupreMOS[®] MOSFET

FCH25N60N — N-Channel SupreMOS[®] MOSFET







SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

intended to be an exhaustive list of	an such trauemarks.		
AccuPower™	F-PFS™		Sync-Lock™
AX-CAP [®] *	FRFET®		SYSTEM ®*
BitSiC™	Global Power Resource SM	PowerTrench [®]	GENERAL
Build it Now™	GreenBridge™	PowerXS™	TinyBoost [®]
CorePLUS™	Green FPS™	Programmable Active Droop™	TinyBuck [®]
CorePOWER™	Green FPS™ e-Series™	QFET®	TinyCalc™
<i>CROSSVOLT</i> ™ CTL™	G <i>max</i> ™ GTO™	QSTM Owiet Series TM	TinyLogic®
Circ™ Current Transfer Logic™	IntelliMAX™	Quiet Series™ RapidConfigure™	TINYOPTO™
	ISOPLANAR™		TinyPower™
Dual Cool™	Marking Small Speakers Sound Lou		TinyPWM™
EcoSPARK [®]	and Better™	Saving our world, 1mW/W/kW at a time™	TinyWire™
EfficentMax™	MegaBuck™	SignalWise™	TranSiC™
ESBC™	MIČROCOUPLER™	SmartMax™	TriFault Detect™ TRUECURRENT [®] *
R	MicroFET™	SMART START™	µSerDes™
+ ~	MicroPak™	Solutions for Your Success™	μoerDes
Fairchild [®]	MicroPak2™	SPM®	SerDes [™]
Fairchild Semiconductor [®]	MillerDrive™	STEALTH™	UHC [®]
FACT Quiet Series™	MotionMax [™]	SuperFET®	Ultra FRFET™
FACT®	mWSaver [®]	SuperSOT™-3	UniFET™
FAST®	OptoHiT™ OPTOLOGIC [®]	SuperSOT™-6 SuperSOT™-8	VCX™
FastvCore™	OPTOPLANAR [®]	SupreMOS [®]	VisualMax™
FETBench™ FPS™		SyncFET™	VoltagePlus™
FF0		0,	XS™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.